



GaN HEMT 28V, UHF ,330W, RF Power Transistor

Description

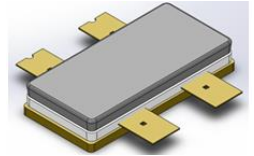
The XTAH09330B4C is a 330W GaN HEMT, internally matched, for multiple application within UHF up to 1GHz It can be used in CW, Pulse and any other modulation modes. There is no guarantee of performance when this part is used in applications designed Outside of these frequencies.

Please note it is configured as single ended with both pins connected at input and output side

- Typical class AB 0.8-0.9GHz RF Performance with device soldered

$V_{ds}=28V$, $I_{dq}=100mA$, CW

Freq (MHz)	P1dB (dBm)	P1dB (W)	P1dB Eff(%)	P1dB Gain(dB)	P3dB (dBm)	P3dB (W)	P3dB Eff(%)
800	54.4	275.3	56.3	18.45	55.55	358.7	64
850	54.58	286.9	64.7	19.41	55.49	353.9	71
900	54.15	259.9	68.1	20.09	54.94	321.1	73



Applications

- P band power amplifier
- UHF power amplifier
- ISM/RF Energy power amplifier

Important Note: Proper Biasing Sequence for GaN HEMT Transistors

Turning the device ON

1. Set VGS to the pinch-off (VP) voltage, typically -5 V
2. Turn on VDS to nominal supply voltage
3. Increase VGS until IDS current is attained
4. Apply RF input power to desired level

Turning the device OFF

1. Turn RF power off
2. Reduce VGS down to VP, typically -5 V
3. Reduce VDS down to 0 V
4. Turn off VGS

Table 1. Maximum Ratings

Rating	Symbol	Value	Unit
Drain--Source Voltage	V_{DSS}	+200	Vdc
Gate--Source Voltage	V_{GS}	-8 to +0.5	Vdc
Operating Voltage	V_{DD}	50	Vdc
Maximum gate current	I_{gs}	94.5	mA
Storage Temperature Range	T_{stg}	-65 to +150	°C
Case Operating Temperature	T_C	+150	°C
Operating Junction Temperature	T_J	+225	°C

Table 2. Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case by FEA $T_C=85^{\circ}C$, at $P_{diss}=150W$	$R_{\theta JC}$	0.58	°C /W

Table 3. Electrical Characteristics ($T_A = 25^{\circ}C$ unless otherwise noted)

DC Characteristics (measured on wafer prior to packaging)

Characteristic	Conditions	Symbol	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	$V_{GS}=-8V$; $I_{DS}=94.5mA$	V_{DSS}		200		V
Gate Threshold Voltage	$V_{DS}=10V$, $I_D=94.5mA$	$V_{GS(th)}$	-4		-2	V

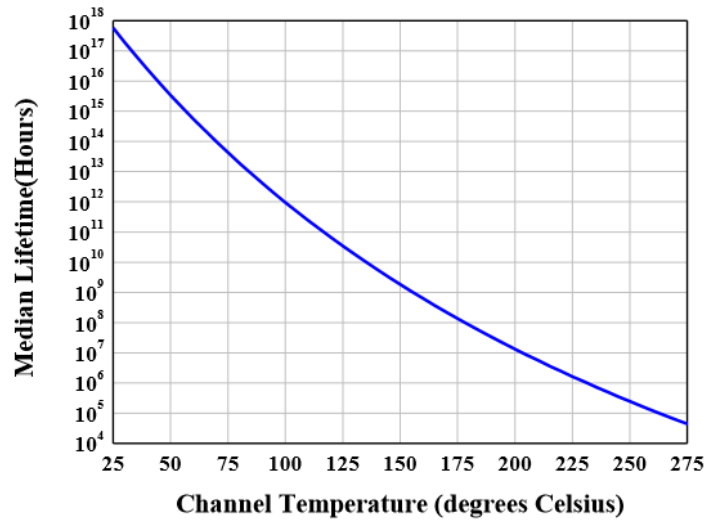


Gate Quiescent Voltage	VDS =28V, IDS=500mA, Measured in Functional Test	V _{GS(Q)}		-3		V
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Ruggedness Characteristics

Characteristic	Conditions	Symbol	Min	Typ	Max	Unit
Load mismatch capability	900MHz, Pout=330W Pulsed CW All phase, No device damages	VSWR		10:1		

Figure 2: Median Lifetime vs. Channel Temperature





0.8-0.9GHz Typical performance

Figure 3: Network analyzer output S11/S21

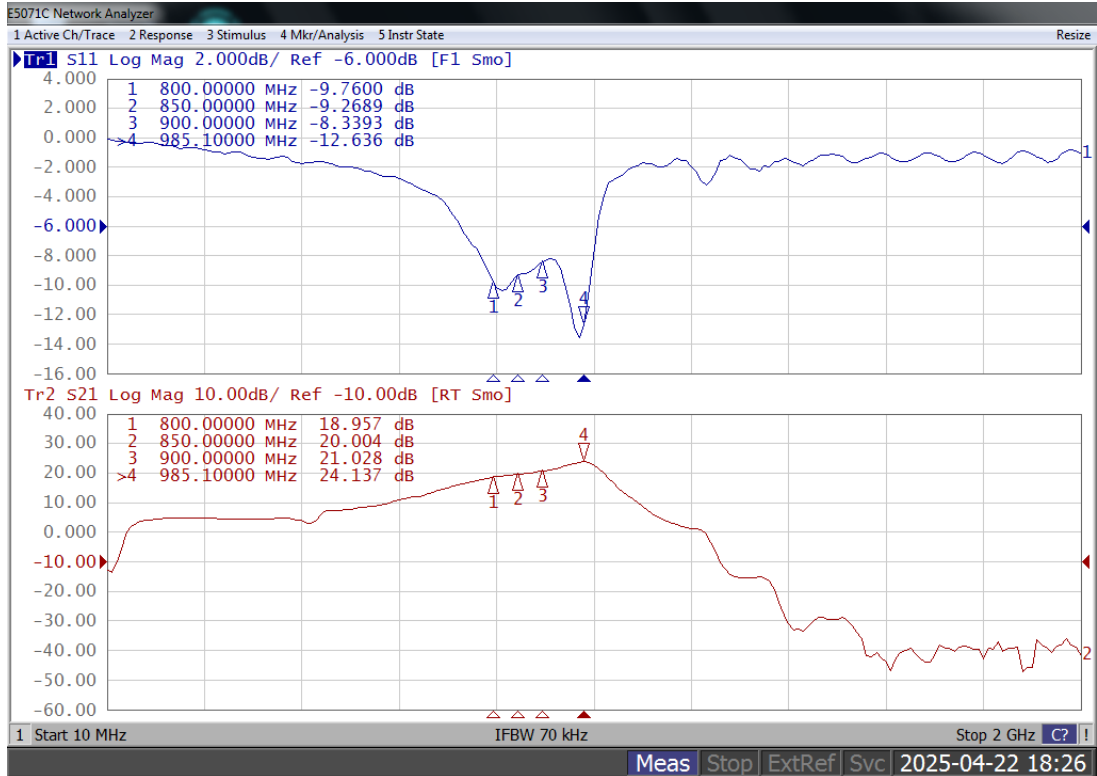
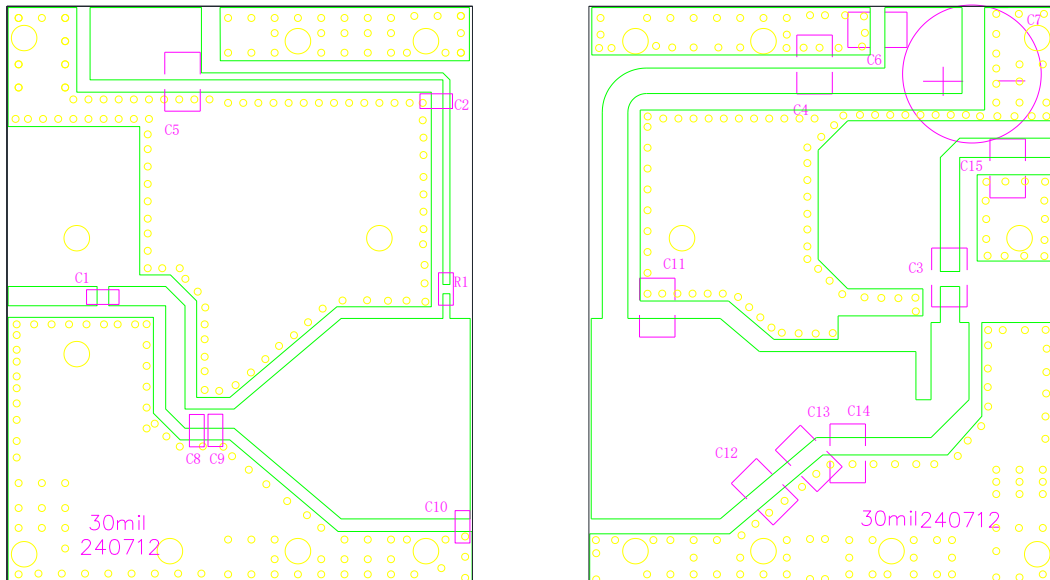


Figure 4: Picture of application board

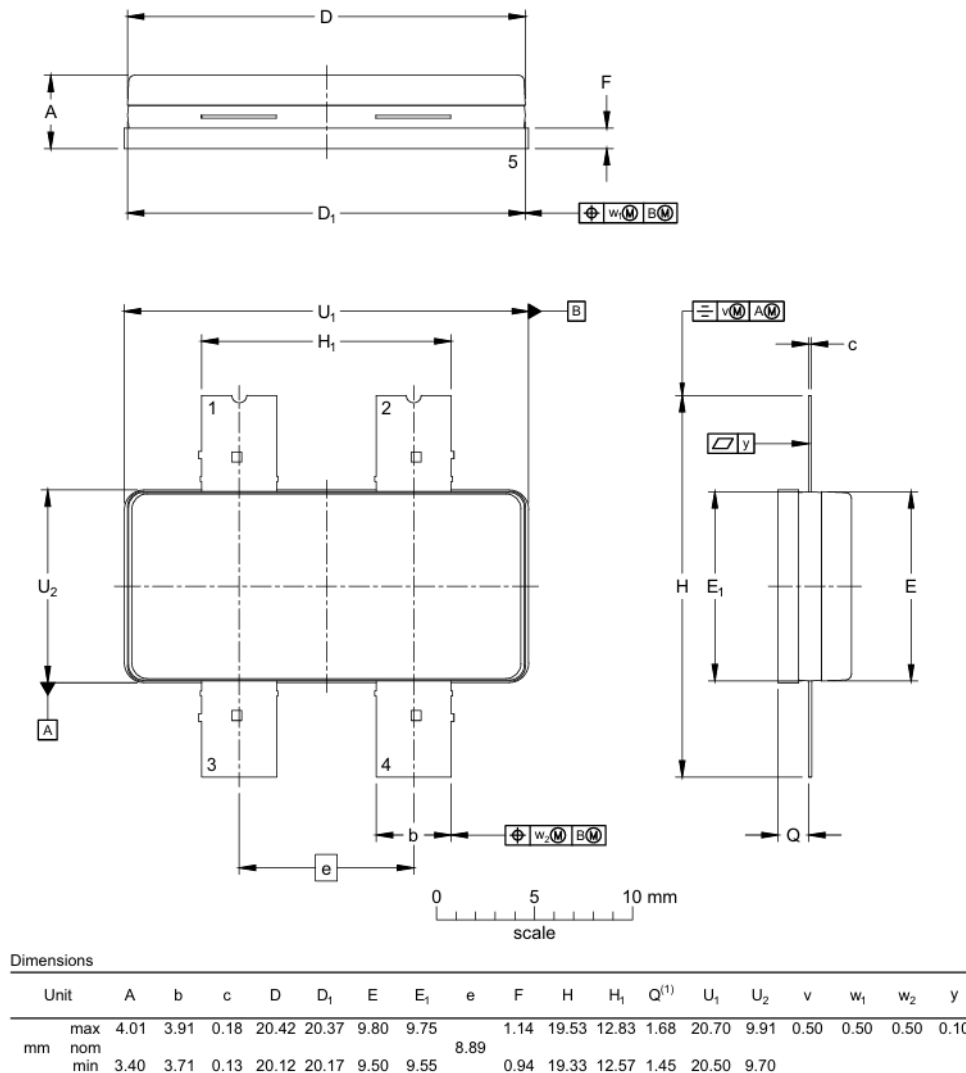




Designator	Comment	Footprint	Quantity
C1, C10	10pF	0603/0805	2
C2	47 pF	0603/0805	1
C3, C4	47 pF	1210	2
C5, C6	10 uF/100V	1210	2
C7	1000 uF/63V		1
R1	10 Ω	0603	1
C9	4.7 pF	0603/0805	1
C8, C9	6.8 pF	0603/0805	1
C11, C12, C14	6.8 pF	1210	3
C13	3.3 pF	0603/0805	1
C15	2.2 pF	1210	1



Earless Flanged Plastic Air Cavity Package; 4 leads



Revision history

Table 4. Document revision history

Date	Revision	Datasheet Status
2025/4/22	V1.0	Preliminary Datasheet Creation

Application data based on: LSM-25-09

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